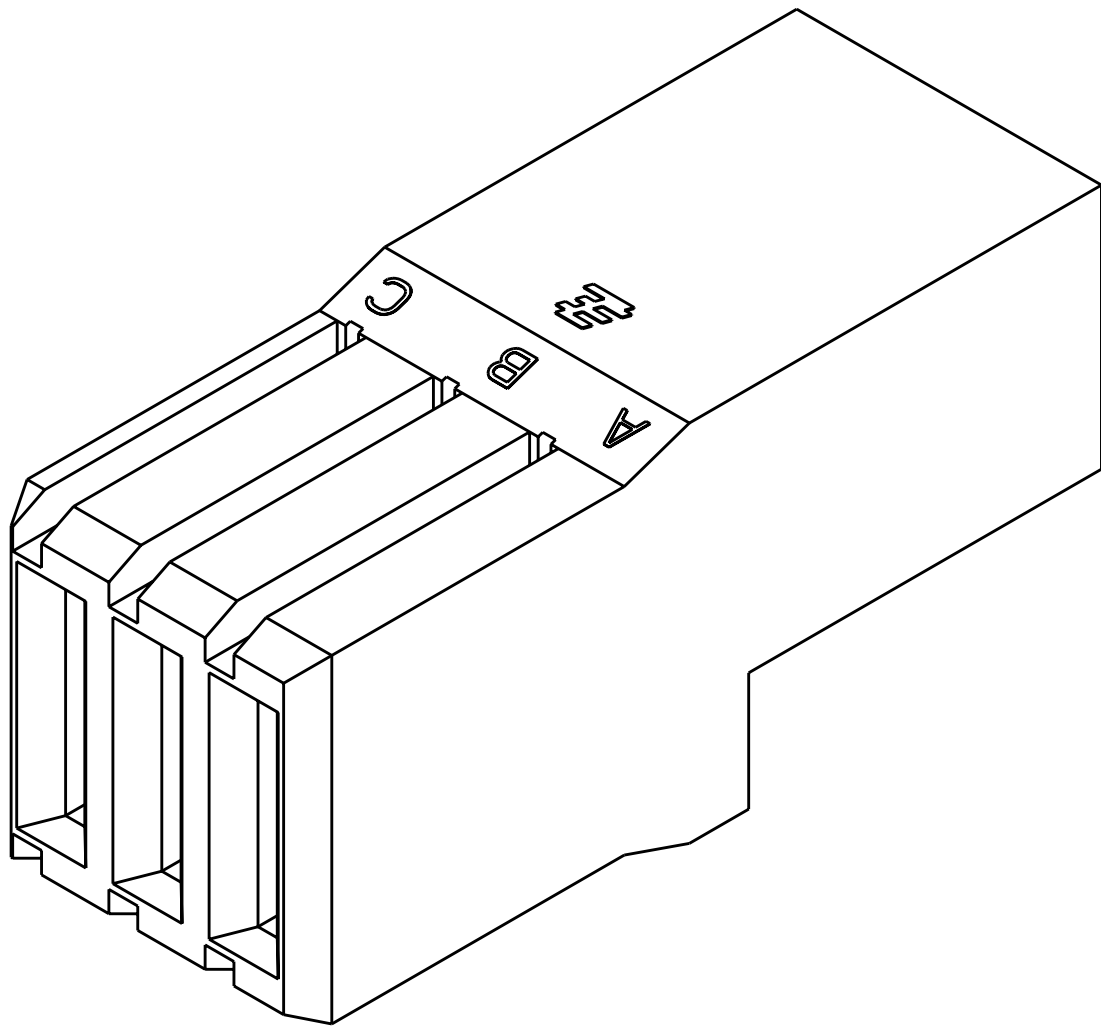
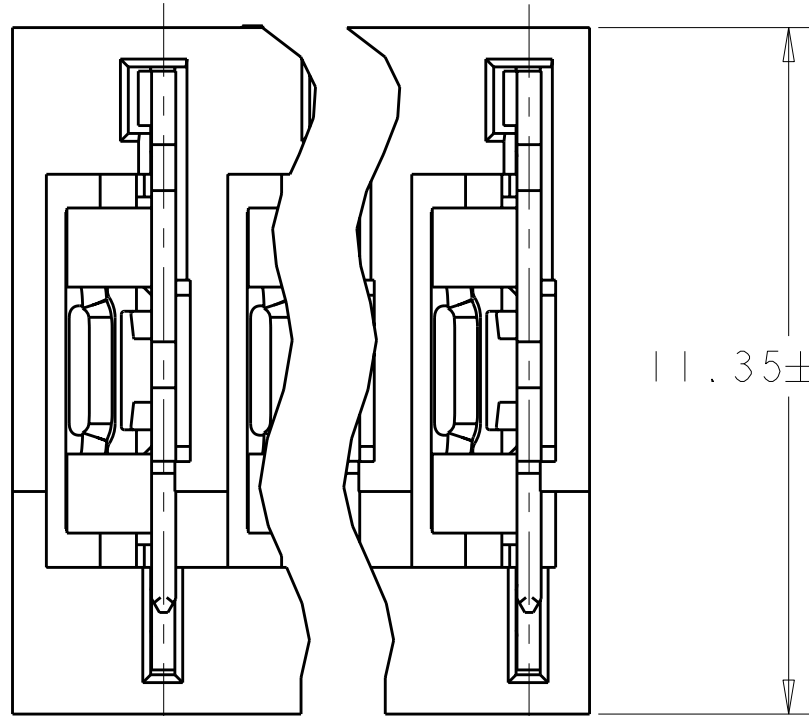


LOC		DIST		REVISIONS			
AD	00	P	LYR	DESCRIPTION	DATE	DWN	APVD
		A1		REVISED PER ECO-11-004917	12MAR2011	RK	HMR



SCALE 6:1



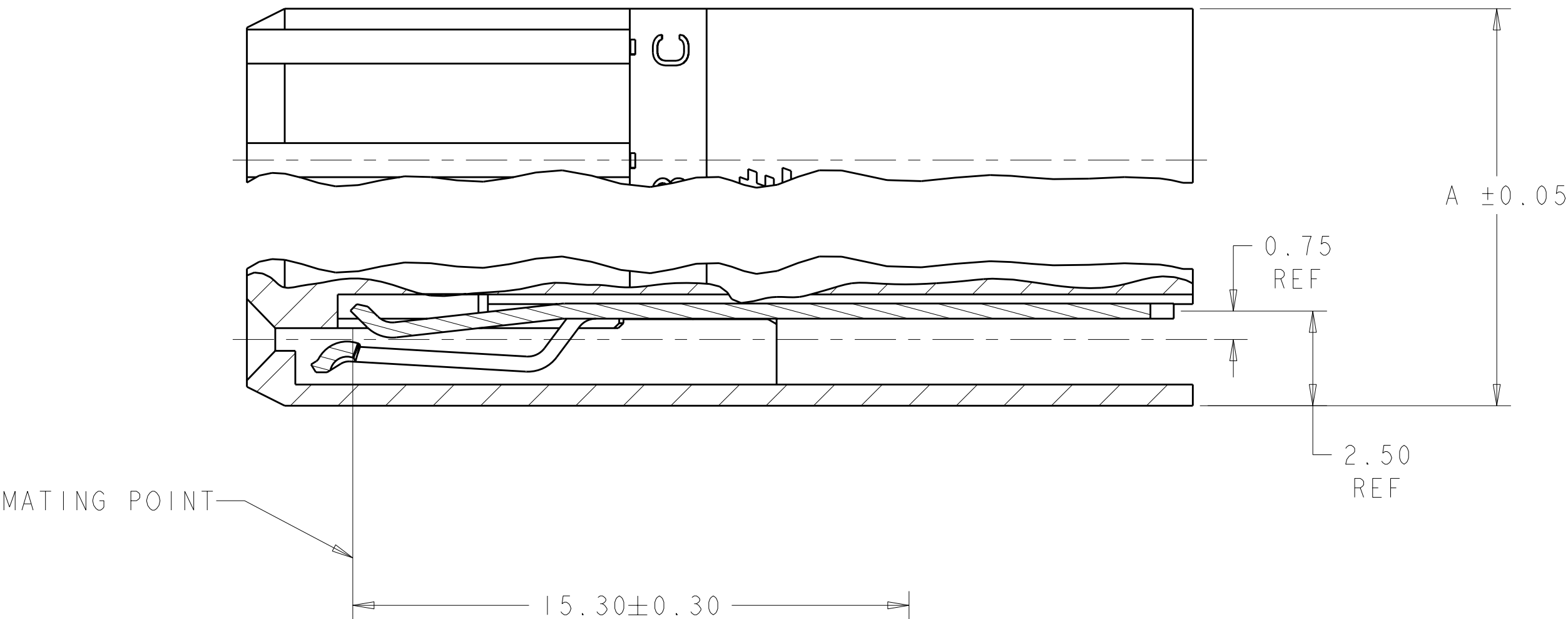
11.35±0.08

2.50 REF C SPACES AT 3.0

- 1 HOUSING: POLYESTER, GRAY.
CONTACT: HIGH CURRENT COPPER ALLOY.
- 2 CONTACT MATING AREA: 1.27µm MIN GOLD PLATE,
ACTION PIN AREA, 0.5µm MIN MATTE TIN PLATE,
ALL OVER 1.27µm MIN NICKEL UNDERPLATE.
- 3 DATE CODE THIS APPROXIMATE AREA.
- 4 REFERENCE APPLICATION SPEC 114-1103 FOR RECOMMENDED
PLATED THRU HOLE DIAMETER & PLATING THICKNESSES.

54	8	12.0	27.50	9	120943-7
48	7	10.5	24.50	8	120943-6
42	6	9.0	21.50	7	120943-5
36	5	7.5	18.50	6	120943-4
30	4	6.0	15.50	5	120943-3
24	3	4.5	12.30	4	120943-2
18	2	3.0	9.50	3	120943-1
D	C	B	A	POSN	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.			DWN	B. CARBO	16JUN2005	 TE Connectivity						
TOLERANCES UNLESS OTHERWISE SPECIFIED:			CHK	R. PATTERSON	16JUN2005							
DIMENSIONS:		APVD		R. PATTERSON	16JUN2005	NAME ASSEMBLY, RIGHT ANGLE, RECEPTACLE, UNIVERSAL POWER MODULE						
mm		PRODUCT SPEC		-								
		APPLICATION SPEC		-								
0 PLC ±.1		SIZE		CASE CODE					DRAWING NO		RESTRICTED TO	
2 PLC ±.1		WEIGHT		-					A100779C=120943		-	
2 PLC ±.1		FINISH		-					CUSTOMER DRAWING		-	
3 PLC ±.1		SCALE		10:1					SHEET		1 OF 1	
4 PLCS ±.1		REV		A					REV		A	
ANGLES		MATERIAL		1		2						
												



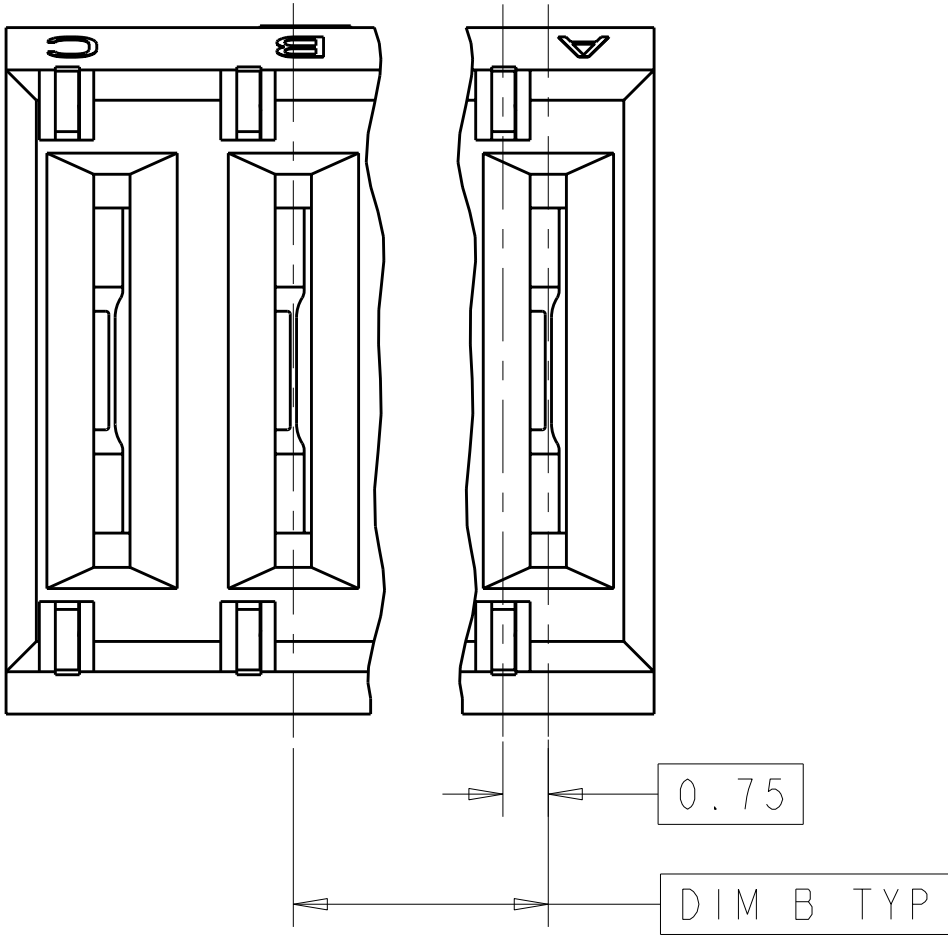
A ±0.05

0.75 REF

2.50 REF

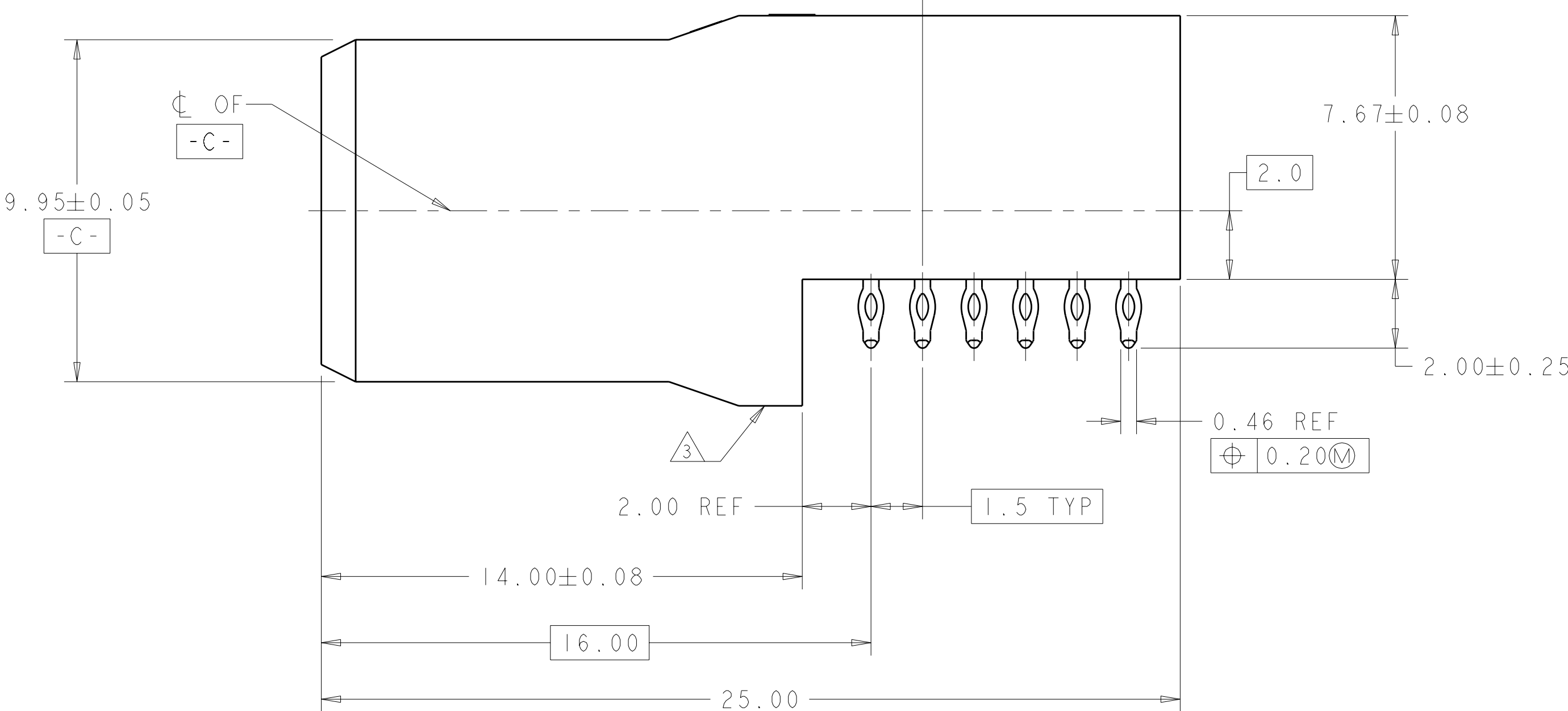
MATING POINT

15.30±0.30



0.75

DIM B TYP



9.95±0.05

CL OF -C-

7.67±0.08

2.0

2.00±0.25

0.46 REF
0.20M

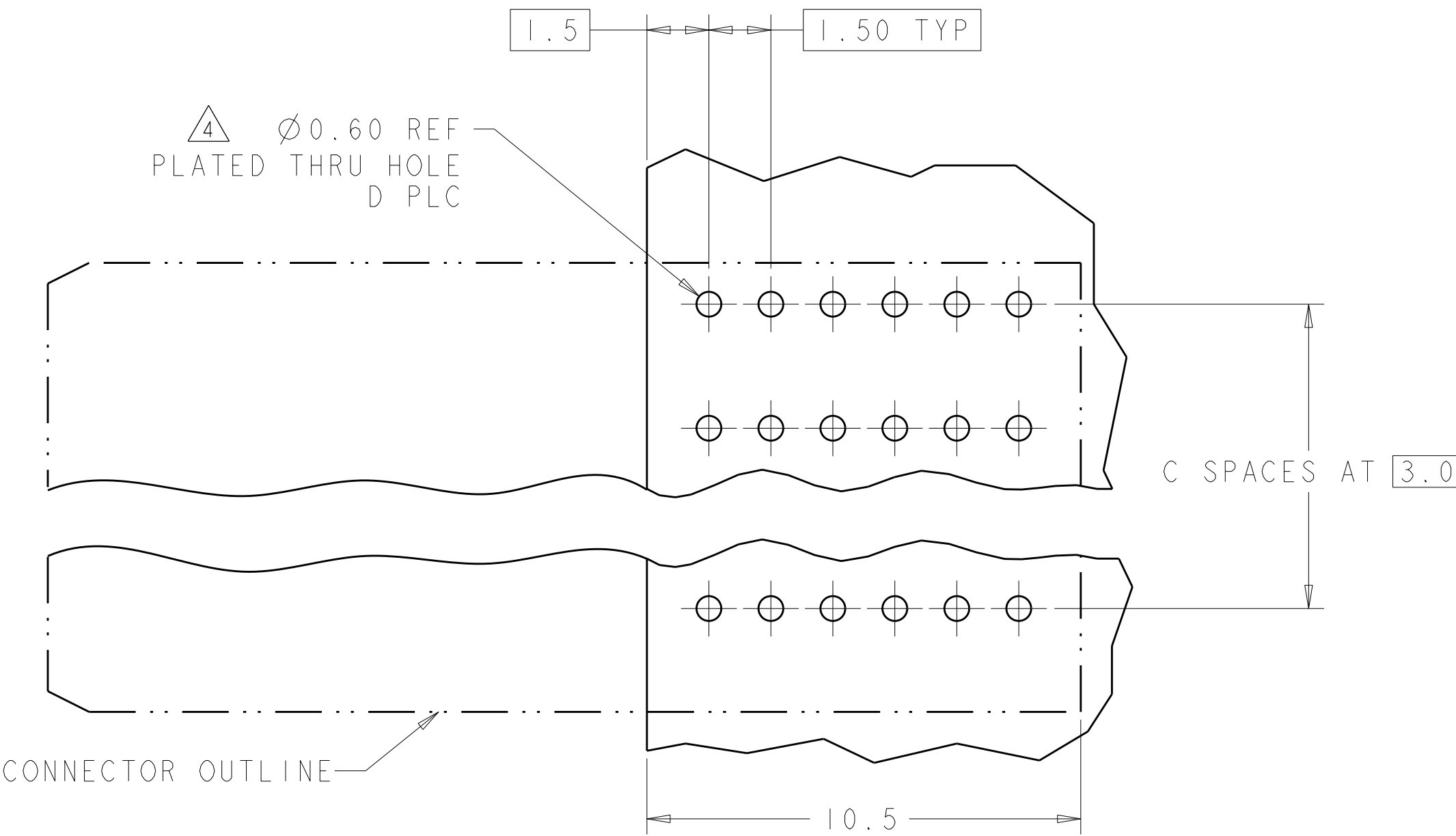
2.00 REF

1.5 TYP

14.00±0.08

16.00

25.00



Ø0.60 REF
PLATED THRU HOLE
D PLC

C SPACES AT 3.0

CONNECTOR OUTLINE

10.5

RECOMMENDED PCB HOLE LAYOUT